Place Block Diagram here (if appropriate) or delete this text box.
If using a block diagram from another tool, save the picture as a .bmp file.
Then, use menu Place|Drawing Tools|Graphic to insert the .png/.svg/.bmp file on the schematic.

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Revision History

<table>
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<th>Rev</th>
<th>Notes</th>
<th>Approved by</th>
<th>ECN #</th>
<th>Approved Date</th>
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You should delete the nylon screws/standoffs and/or the bumpons as needed for your design (or substitute other parts from Hardware.IntLib). Bumpons are cheaper, but provide less clearance.

Deleting anything else from this page may result in your EVM submission being rejected until you add them back.

Update the Label Text in the Label Table as needed for each Assembly Variant.

You should delete this note too.

<table>
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<th>Label Text</th>
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<tr>
<td>002</td>
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</table>

Assembly Note

ZZ1

These assemblies must comply with workmanship standards IPC-A-610 Class 2, unless otherwise specified.

ZZ2

These assembly notes are ESD sensitive. ESD precautions shall be observed.

ZZ3

These assembly notes must be clean and free from flux and all contaminants. Use of no clean flux is not acceptable.

ZZ4

These assemblies must comply with workmanship standards IPC-A-610 Class 2, unless otherwise specified.
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